

GLASS PASSIVATED SUPER FAST RECTIFIER

FEATURES

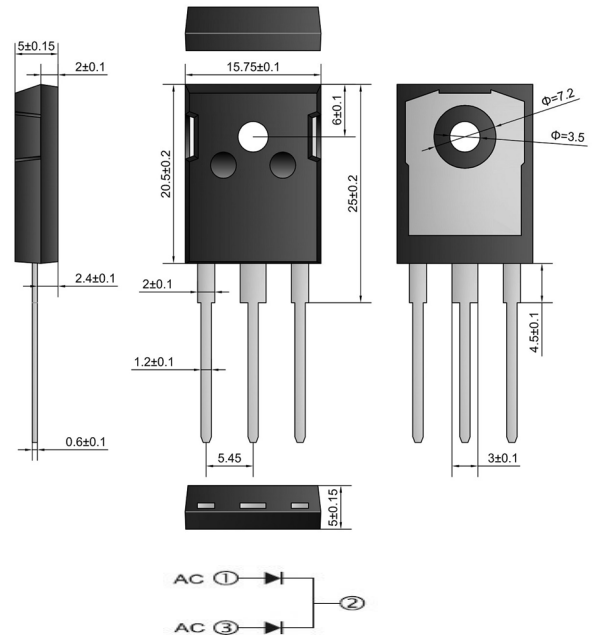
- Fred Chip Planar Construction
- SuperFast Switching,High Efficiency
- Low Power loss, High Efficiency
- Low Reverse Leakage Curren
- High Surge Current Capability
- Plastic Material has UL Flammability Classification 94V-O

MECHANICAL DATA

- Case: TO-247AD/TO-3P, Molded Plas
- Terminals:Pure tin Plated ,Lead free Solderable per MIL-STD-750, Method 2026
- Polarity: As marked
- Weight: 6.4 grams(approx)
- Mounting Position:Any

TO-247AD / TO-3P

unit:mm



Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	MUR8030PT	MUR8040PT	Unit
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	300	400	V
Maximum RMS Voltage	V_{RMS}	210	280	V
Maximum DC Blocking Voltage	V_{DC}	300	400	V
Maximum Average Forward (See Figure 1)	$I_{F(AV)}$	80		A
Peak Forward Surge Current : 8.3ms single half sine-wave superimposed on rated load(JEDEC method)	I_{FSM}	350		A
Maximum Forward Voltage at 40A per leg	V_F	Typ.	Max.	V
		1.15	1.3	
Maximum Reverse Recovery Time (Measured With $I_F=0.5A$, $I_R=1.0A$, $IRR=0.25A$)	T_{rr}	Typ.	Max.	nS
		45	50	
Maximum DC Reverse Current at Rated DC Blocking Voltag	I_R	$T_A = 25^\circ\text{C}$	5	μA
		$T_A = 100^\circ\text{C}$	500	
Typical Thermal Resistance Junction to case	$R_{\theta JC}$	1.5		$^\circ\text{C}/\text{W}$
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$	45		$^\circ\text{C}/\text{W}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to +150		$^\circ\text{C}$

RATING AND CHARACTERISTIC CUEVES

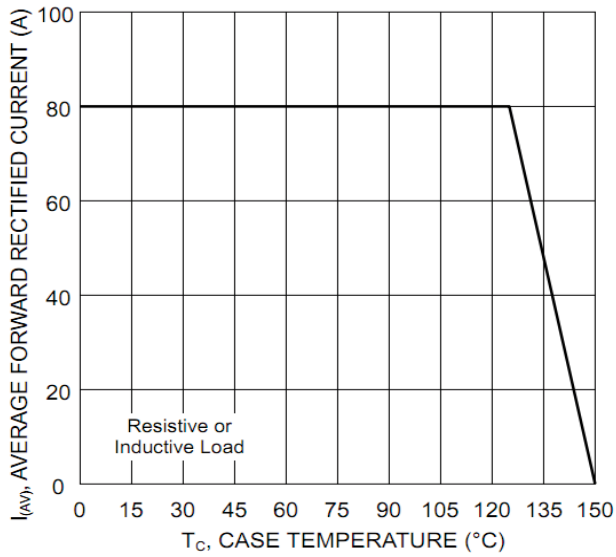


Fig-1
FORWARD CURRENT DERATING CURVE

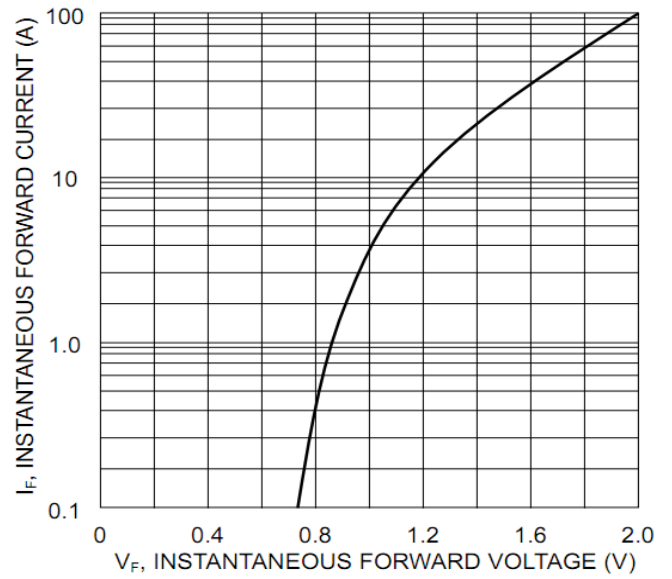


Fig-2
TYPICAL INSTANTANEOUS FORWARD CHARACTERISTIC

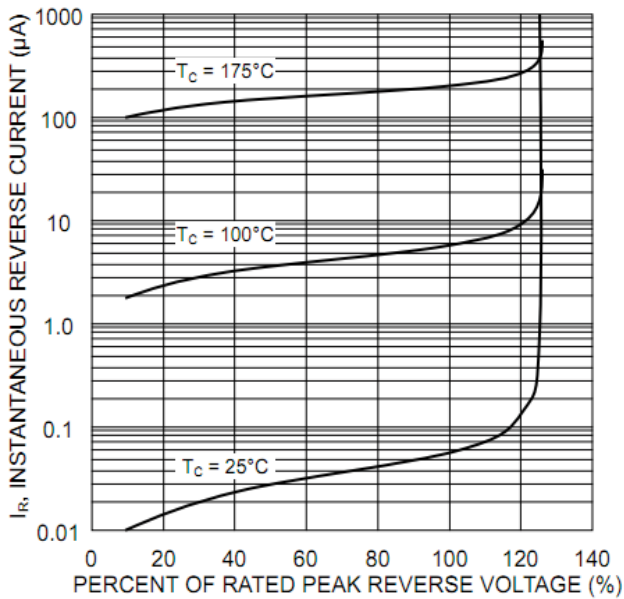


Fig-3
TYPICAL REVERSE CHARACTERISTICS

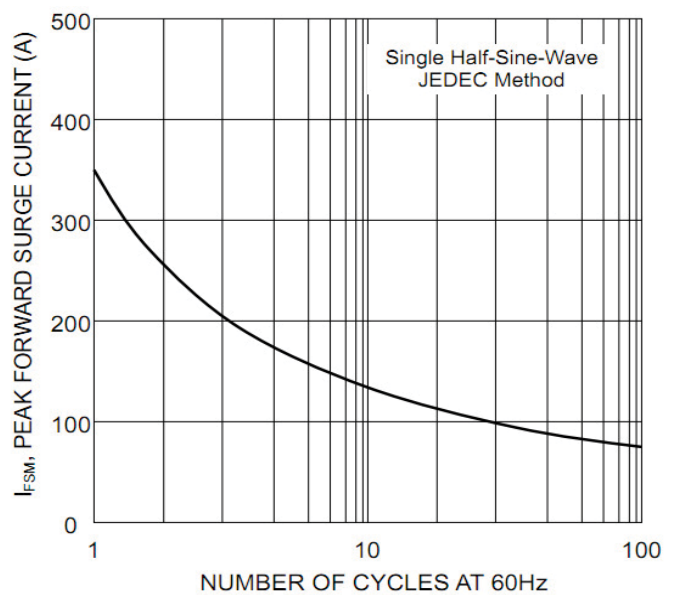


Fig-4
MAXIMUM NON-REPETITIVE SURGE CURRENT